



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	IPD65R1K4C6	<b>Issued</b>	02. June 2021
<b>MA#</b>	MA001720640		
<b>Package</b>	PG-TO252-3-341	<b>Weight*</b>	387.80 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.898	0.49	0.49	4893	4893
leadframe	inorganic material	phosphorus	7723-14-0	0.069	0.02		177	
	non noble metal	iron	7439-89-6	0.229	0.06		591	
	non noble metal	copper	7440-50-8	228.946	59.03	59.11	590369	591137
wire	non noble metal	aluminium	7429-90-5	0.414	0.11	0.11	1067	1067
encapsulation	organic material	carbon black	1333-86-4	0.392	0.10		1011	
	plastics	epoxy resin	-	11.894	3.07		30670	
	inorganic material	silicon dioxide	60676-86-0	118.416	30.54	33.71	305351	337032
leadfinish	non noble metal	tin	7440-31-5	3.740	0.96	0.96	9644	9644
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1312	1312
solder	non noble metal	tin	7440-31-5	0.042	0.01		108	
	noble metal	silver	7440-22-4	0.052	0.01		135	
	non noble metal	lead	7439-92-1	1.999	0.52	0.54	5155	5398
heatspreader	inorganic material	phosphorus	7723-14-0	0.006			15	
	non noble metal	iron	7439-89-6	0.019			50	
	non noble metal	copper	7440-50-8	19.177	4.95	4.95	49452	49517
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com